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## BIB DATA SHEET

CONFIRMATION NO. 4300

SERIAL NUMBER	FILING or 371(c) DATE RULE	CLASS	GROUP ART UNIT	ATTORNEY DOCKET NO.
10/536,725		438	2813	49016

## APPLICANTS

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## \*\* CONTINUING DATA \*\*\*\*\*

This application is a 371 of PCT/EP03/13434 11/28/2003

## \*\* FOREIGN APPLICATIONS \*\*\*\*\*

GERMANY 102 56 247.4 11/29/2002  
 GERMANY 103 53 530.6 11/14/2003

## \*\* IF REQUIRED, FOREIGN FILING LICENSE GRANTED \*\*

Foreign Priority claimed	<input checked="" type="checkbox"/> Yes <input type="checkbox"/> No	<input checked="" type="checkbox"/> Yes <input type="checkbox"/> No	<input type="checkbox"/> Met after Allowance	STATE OR COUNTRY	SHEETS DRAWINGS	TOTAL CLAIMS	INDEPENDENT CLAIMS
35 USC 119(a-d) conditions met	<input checked="" type="checkbox"/>	<input type="checkbox"/>		GERMANY	6	40	3
Verified and /LAURA MARY MENZ/ Acknowledged Examiner's Signature			Initials				

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## TITLE

Method and device for machining a wafer, in addition to a wafer comprising a separation layer and a support layer

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